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"Embedded - Microcontrollers" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

Applications of "<u>Embedded -</u> <u>Microcontrollers</u>"

Details

Product Status	Active
Core Processor	MIPS32® M4K™
Core Size	32-Bit Single-Core
Speed	40MHz
Connectivity	I ² C, IrDA, LINbus, PMP, SPI, UART/USART
Peripherals	Brown-out Detect/Reset, DMA, I ² S, POR, PWM, WDT
Number of I/O	21
Program Memory Size	32KB (32K x 8)
Program Memory Type	FLASH
EEPROM Size	-
RAM Size	8K x 8
Voltage - Supply (Vcc/Vdd)	2.3V ~ 3.6V
Data Converters	A/D 10x10b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	28-VQFN Exposed Pad
Supplier Device Package	28-QFN (6x6)
Purchase URL	https://www.e-xfl.com/product-detail/microchip-technology/pic32mx120f032bt-i-ml

Email: info@E-XFL.COM

Address: Room A, 16/F, Full Win Commercial Centre, 573 Nathan Road, Mongkok, Hong Kong

2.9 Typical Application Connection Examples

Examples of typical application connections are shown in Figure 2-5 and Figure 2-6.



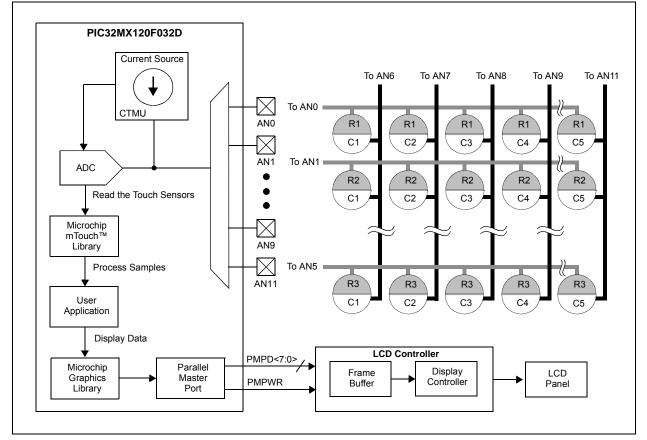
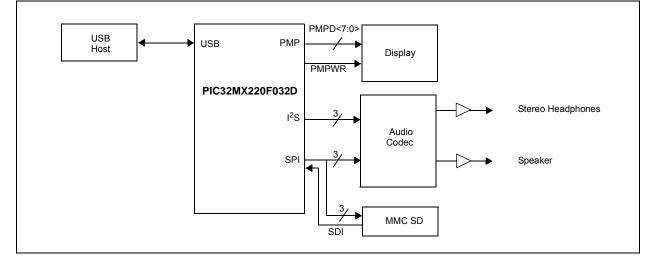


FIGURE 2-6: AUDIO PLAYBACK APPLICATION



PIC32MX1XX/2XX 28/36/44-PIN FAMILY

Bit Range	Bit 31/23/15/7	Bit 30/22/14/6	Bit 29/21/13/5	Bit 28/20/12/4	Bit 27/19/11/3	Bit 26/18/10/2	Bit 25/17/9/1	Bit 24/16/8/0		
31:24	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0		
	_	_		_	_	—	—	—		
00.40	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0		
23:16	_	_		_	_	_	—	—		
45.0	U-0	U-0	U-0	R/W-0	U-0	R/W-0	R/W-0	R/W-0		
15:8	—	_	—	MVEC	_	TPC<2:0>				
7:0	U-0	U-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0		
7:0	_	_	_	INT4EP	INT3EP	INT2EP	INT1EP	INT0EP		

REGISTER 7-1: INTCON: INTERRUPT CONTROL REGISTER

Legend:

Logona.						
R = Readable bit W = Writable bit		U = Unimplemented bit, read as '0'				
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown			

bit 31-16 Unimplemented: Read as '0'

bit 15-13 Unimplemented: Read as '0'

- bit 12 MVEC: Multi Vector Configuration bit
 - 1 = Interrupt controller configured for Multi-vectored mode
 - 0 = Interrupt controller configured for Single-vectored mode
- bit 11 Unimplemented: Read as '0'
- bit 10-8 **TPC<2:0>:** Interrupt Proximity Timer Control bits
 - 111 = Interrupts of group priority 7 or lower start the Interrupt Proximity timer
 - 110 = Interrupts of group priority 6 or lower start the Interrupt Proximity timer
 - 101 = Interrupts of group priority 5 or lower start the Interrupt Proximity timer
 - 100 = Interrupts of group priority 4 or lower start the Interrupt Proximity timer
 - 011 = Interrupts of group priority 3 or lower start the Interrupt Proximity timer
 - 010 = Interrupts of group priority 2 or lower start the Interrupt Proximity timer
 - 001 = Interrupts of group priority 1 start the Interrupt Proximity timer
 - 000 = Disables Interrupt Proximity timer

bit 7-5 Unimplemented: Read as '0'

- bit 4 INT4EP: External Interrupt 4 Edge Polarity Control bit
 - 1 = Rising edge
 - 0 = Falling edge
- bit 3 INT3EP: External Interrupt 3 Edge Polarity Control bit
 - 1 = Rising edge
 - 0 = Falling edge
- bit 2 INT2EP: External Interrupt 2 Edge Polarity Control bit
 - 1 = Rising edge
 - 0 = Falling edge
- bit 1 INT1EP: External Interrupt 1 Edge Polarity Control bit
 - 1 = Rising edge
 - 0 = Falling edge
- bit 0 INTOEP: External Interrupt 0 Edge Polarity Control bit
 - 1 = Rising edge
 - 0 = Falling edge

REGISTER 8-1: OSCCON: OSCILLATOR CONTROL REGISTER

bit 3	CF: Clock Fail Detect bit
	1 = FSCM has detected a clock failure
	0 = No clock failure has been detected
bit 2	UFRCEN: USB FRC Clock Enable bit ⁽¹⁾
	 1 = Enable the FRC as the clock source for the USB clock source 0 = Use the Primary Oscillator or USB PLL as the USB clock source
bit 1	SOSCEN: Secondary Oscillator (Sosc) Enable bit
	1 = Enable the Secondary Oscillator
	0 = Disable the Secondary Oscillator
bit 0	OSWEN: Oscillator Switch Enable bit
	 1 = Initiate an oscillator switch to selection specified by NOSC<2:0> bits 0 = Oscillator switch is complete
Note 1:	This bit is only available on PIC32MX2XX devices.

Note: Writes to this register require an unlock sequence. Refer to Section 6. "Oscillator" (DS60001112) in the "PIC32 Family Reference Manual" for details.

REGISTER 9-4: DCRCCON: DMA CRC CONTROL REGISTER (CONTINUED)

bit 6 **CRCAPP:** CRC Append Mode bit⁽¹⁾

- 1 = The DMA transfers data from the source into the CRC but NOT to the destination. When a block transfer completes the DMA writes the calculated CRC value to the location given by CHxDSA
- 0 = The DMA transfers data from the source through the CRC obeying WBO as it writes the data to the destination
- bit 5 **CRCTYP:** CRC Type Selection bit
 - 1 = The CRC module will calculate an IP header checksum
 - 0 = The CRC module will calculate a LFSR CRC
- bit 4-3 Unimplemented: Read as '0'
- bit 2-0 CRCCH<2:0>: CRC Channel Select bits
 - 111 = CRC is assigned to Channel 7
 - 110 = CRC is assigned to Channel 6
 - 101 = CRC is assigned to Channel 5
 - 100 = CRC is assigned to Channel 4
 - 011 = CRC is assigned to Channel 3
 - 010 = CRC is assigned to Channel 2
 - 001 = CRC is assigned to Channel 1
 - 000 = CRC is assigned to Channel 0
- **Note 1:** When WBO = 1, unaligned transfers are not supported and the CRCAPP bit cannot be set.

Bit Range	Bit 31/23/15/7	Bit 30/22/14/6	Bit 29/21/13/5	Bit 28/20/12/4	Bit 27/19/11/3	Bit 26/18/10/2	Bit 25/17/9/1	Bit 24/16/8/0		
24.24	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0		
31:24				DCRCDAT	4<31:24>					
00.10	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0		
23:16	DCRCDATA<23:16>									
15.0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0		
15:8	DCRCDATA<15:8>									
7.0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0		
7:0				DCRCDA	TA<7:0>					

REGISTER 9-5: DCRCDATA: DMA CRC DATA REGISTER

Legend:

Legend:						
R = Readable bit	W = Writable bit	U = Unimplemented bi	U = Unimplemented bit, read as '0'			
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown			

bit 31-0 DCRCDATA<31:0>: CRC Data Register bits

Writing to this register will seed the CRC generator. Reading from this register will return the current value of the CRC. Bits greater than PLEN will return '0' on any read.

<u>When CRCTYP (DCRCCON<15>) = 1</u> (CRC module is in IP Header mode): Only the lower 16 bits contain IP header checksum information. The upper 16 bits are always '0'. Data written to this register is converted and read back in 1's complement form (i.e., current IP header checksum value).

<u>When CRCTYP (DCRCCON<15>) = 0</u> (CRC module is in LFSR mode): Bits greater than PLEN will return '0' on any read.

REGISTER 9-6: DCRCXOR: DMA CRCXOR ENABLE REGISTER

Bit Range	Bit 31/23/15/7	Bit 30/22/14/6	Bit 29/21/13/5	Bit 28/20/12/4	Bit 27/19/11/3	Bit 26/18/10/2	Bit 25/17/9/1	Bit 24/16/8/0	
	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	
31:24				DCRCXOF	<31:24>				
00.40	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	
23:16	DCRCXOR<23:16>								
45.0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	
15:8	DCRCXOR<15:8>								
7.0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	
7:0				DCRCXO	R<7:0>				

Legend:					
R = Readable bit	W = Writable bit	U = Unimplemented b	mplemented bit, read as '0'		
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown		

bit 31-0 DCRCXOR<31:0>: CRC XOR Register bits

<u>When CRCTYP (DCRCCON<15>) = 1</u> (CRC module is in IP Header mode): This register is unused.

When CRCTYP (DCRCCON<15>) = 0 (CRC module is in LFSR mode):

- 1 = Enable the XOR input to the Shift register
- 0 = Disable the XOR input to the Shift register; data is shifted in directly from the previous stage in the register

10.0 USB ON-THE-GO (OTG)

Note: This data sheet summarizes the features of the PIC32MX1XX/2XX 28/36/44-pin Family of devices. It is not intended to be a comprehensive reference source. To complement the information in this data sheet, refer to Section 27. "USB On-The-Go (OTG)" (DS60001126), which is available from the Documentation > Reference Manual section of the Microchip PIC32 web site (www.microchip.com/pic32).

The Universal Serial Bus (USB) module contains analog and digital components to provide a USB 2.0 Full-Speed and Low-Speed embedded host, Full-Speed device or OTG implementation with a minimum of external components. This module in Host mode is intended for use as an embedded host and therefore does not implement a UHCI or OHCI controller.

The USB module consists of the clock generator, the USB voltage comparators, the transceiver, the Serial Interface Engine (SIE), a dedicated USB DMA controller, pull-up and pull-down resistors, and the register interface. A block diagram of the PIC32 USB OTG module is presented in Figure 10-1.

The clock generator provides the 48 MHz clock required for USB Full-Speed and Low-Speed communication. The voltage comparators monitor the voltage on the VBUS pin to determine the state of the bus. The transceiver provides the analog translation between the USB bus and the digital logic. The SIE is a state machine that transfers data to and from the endpoint buffers and generates the hardware protocol for data transfers. The USB DMA controller transfers data between the data buffers in RAM and the SIE. The integrated pull-up and pull-down resistors eliminate the need for external signaling components. The register interface allows the CPU to configure and communicate with the module. The PIC32 USB module includes the following features:

- · USB Full-Speed support for Host and Device
- Low-Speed Host support
- USB OTG support
- · Integrated signaling resistors
- Integrated analog comparators for VBUS monitoring
- Integrated USB transceiver
- · Transaction handshaking performed by hardware
- · Endpoint buffering anywhere in system RAM
- · Integrated DMA to access system RAM and Flash
- Note: The implementation and use of the USB specifications, as well as other third party specifications or technologies, may require licensing; including, but not limited to, USB Implementers Forum, Inc., also referred to as USB-IF (www.usb.org). The user is fully responsible for investigating and satisfying any applicable licensing obligations.

11.0 I/O PORTS

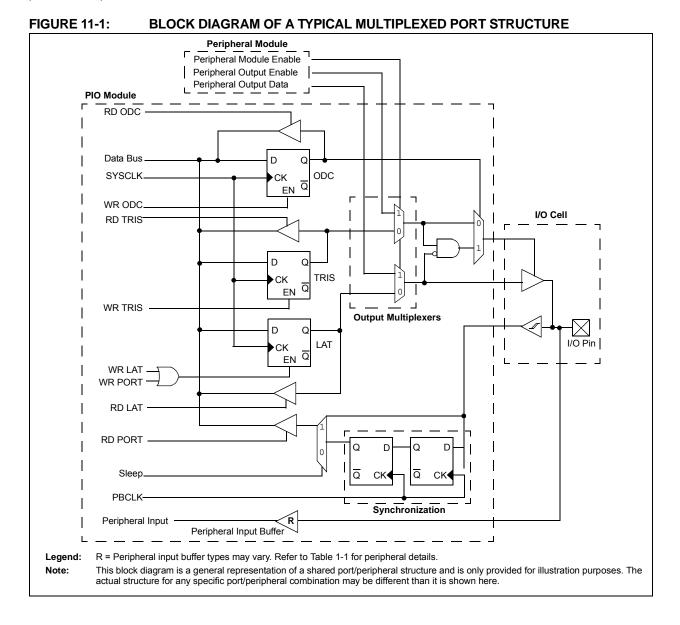
Note: This data sheet summarizes the features of the PIC32MX1XX/2XX 28/36/44-pin Family of devices. It is not intended to be a comprehensive reference source. To complement the information in this data sheet, refer to Section 12. "I/O Ports" (DS60001120), which is available from the *Documentation* > *Reference Manual* section of the Microchip PIC32 web site (www.microchip.com/pic32).

General purpose I/O pins are the simplest of peripherals. They allow the PIC[®] MCU to monitor and control other devices. To add flexibility and functionality, some pins are multiplexed with alternate functions. These functions depend on which peripheral features are on the device. In general, when a peripheral is functioning, that pin may not be used as a general purpose I/O pin.

Key features of this module include:

- · Individual output pin open-drain enable/disable
- · Individual input pin weak pull-up and pull-down
- Monitor selective inputs and generate interrupt when change in pin state is detected
- · Operation during Sleep and Idle modes
- Fast bit manipulation using CLR, SET, and INV registers

Figure 11-1 illustrates a block diagram of a typical multiplexed I/O port.



Bit Range	Bit 31/23/15/7	Bit 30/22/14/6	Bit 29/21/13/5	Bit 28/20/12/4	Bit 27/19/11/3	Bit 26/18/10/2	Bit 25/17/9/1	Bit 24/16/8/0
31:24	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
31.24		—			_	_	_	_
23:16	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
23.10	-	—			_	_	-	_
15:8	R/W-0	U-0	R/W-0	R/W-0	R-0	U-0	U-0	U-0
10.0	ON ⁽¹⁾	—	SIDL	TWDIS	TWIP	—	-	_
7:0	R/W-0	U-0	R/W-0	R/W-0	U-0	R/W-0	R/W-0	U-0
7.0	TGATE		TCKPS	S<1:0>		TSYNC	TCS	

REGISTER 12-1: T1CON: TYPE A TIMER CONTROL REGISTER

Legend:

R = Readable bit W = Writable bit		U = Unimplemented bit, read as '0'			
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown		

bit 31-16 Unimplemented: Read as '0'

- bit 15 **ON:** Timer On bit⁽¹⁾
 - 1 = Timer is enabled
 - 0 = Timer is disabled

bit 14 Unimplemented: Read as '0'

bit 13 **SIDL:** Stop in Idle Mode bit

1 = Discontinue module operation when the device enters Idle mode0 = Continue module operation when the device enters Idle mode

bit 12 **TWDIS:** Asynchronous Timer Write Disable bit

- 1 = Writes to Timer1 are ignored until pending write operation completes
- 0 = Back-to-back writes are enabled (Legacy Asynchronous Timer functionality)

bit 11 **TWIP:** Asynchronous Timer Write in Progress bit

In Asynchronous Timer mode:

- 1 = Asynchronous write to the Timer1 register in progress
- 0 = Asynchronous write to Timer1 register is complete
- In Synchronous Timer mode:

This bit is read as '0'.

- bit 10-8 **Unimplemented:** Read as '0'
- bit 7 TGATE: Timer Gated Time Accumulation Enable bit
 - When TCS = 1:

This bit is ignored.

When TCS = 0:

- 1 = Gated time accumulation is enabled
- 0 = Gated time accumulation is disabled

bit 6 Unimplemented: Read as '0'

bit 5-4 TCKPS<1:0>: Timer Input Clock Prescale Select bits

- 11 = 1:256 prescale value
- 10 = 1:64 prescale value
- 01 = 1:8 prescale value
- 00 = 1:1 prescale value
- **Note 1:** When using 1:1 PBCmLK divisor, the user's software should not read/write the peripheral SFRs in the SYSCLK cycle immediately following the instruction that clears the module's ON bit.

PIC32MX1XX/2XX 28/36/44-PIN FAMILY

Bit Range	Bit 31/23/15/7	Bit 30/22/14/6	Bit 29/21/13/5	Bit 28/20/12/4	Bit 27/19/11/3	Bit 26/18/10/2	Bit 25/17/9/1	Bit 24/16/8/0
21.24	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
31:24	—		—	-	—	-	—	—
00.40	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
23:16	—	-	—	_	_	_	—	—
45.0	R/W-0	U-0	R/W-0	U-0	U-0	U-0	U-0	U-0
15:8	ON ^(1,3)	_	SIDL ⁽⁴⁾	_	—	—	—	—
7:0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	U-0	R/W-0	U-0
7:0	TGATE ⁽³⁾	Т	CKPS<2:0>(3)	T32 ⁽²⁾	—	TCS ⁽³⁾	—

REGISTER 13-1: TXCON: TYPE B TIMER CONTROL REGISTER

Legend:

R = Readable bit	= Readable bit W = Writable bit		U = Unimplemented bit, read as '0'				
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown				

bit 31-16 **Unimplemented:** Read as '0'

- bit 15 **ON:** Timer On bit^(1,3)
 - 1 = Module is enabled
 - 0 = Module is disabled
- bit 14 Unimplemented: Read as '0'
- bit 13 SIDL: Stop in Idle Mode bit⁽⁴⁾
 - 1 = Discontinue module operation when the device enters Idle mode0 = Continue module operation when the device enters Idle mode

bit 12-8 Unimplemented: Read as '0'

- bit 7 **TGATE:** Timer Gated Time Accumulation Enable bit⁽³⁾
 - When TCS = 1:

This bit is ignored and is read as '0'.

When TCS = 0:

1 = Gated time accumulation is enabled

0 = Gated time accumulation is disabled

bit 6-4 **TCKPS<2:0>:** Timer Input Clock Prescale Select bits⁽³⁾

- 111 = 1:256 prescale value
- 110 = 1:64 prescale value
- 101 = 1:32 prescale value
- 100 = 1:16 prescale value
- 011 = 1:8 prescale value
- 010 = 1:4 prescale value
- 001 = 1:2 prescale value

000 = 1:1 prescale value

- **Note 1:** When using 1:1 PBCLK divisor, the user's software should not read/write the peripheral SFRs in the SYSCLK cycle immediately following the instruction that clears the module's ON bit.
 - 2: This bit is available only on even numbered timers (Timer2 and Timer4).
 - **3:** While operating in 32-bit mode, this bit has no effect for odd numbered timers (Timer3, and Timer5). All timer functions are set through the even numbered timers.
 - 4: While operating in 32-bit mode, this bit must be cleared on odd numbered timers to enable the 32-bit timer in Idle mode.

14.1 Watchdog Timer Control Registers

TABLE 14-1: WATCHDOG TIMER CONTROL REGISTER MAP

ess				Bits												s			
Virtual Addre (BF80_#)	Register Name ⁽¹⁾	Bit Range	31/15	30/14	29/13	28/12	27/11	26/10	25/9	24/8	23/7	22/6	21/5	20/4	19/3	18/2	17/1	16/0	All Resets
0000	WDTCON	31:16	_	—	_	—	_		_	_	-	_	_	_	_	—	-	—	0000
0000	WDICON	15:0	ON	_		_	_	_		_			SI	VDTPS<4:	0>		WDTWINEN	WDTCLR	0000

Legend: x = unknown value on Reset; --- = unimplemented, read as '0'. Reset values are shown in hexadecimal.

Note 1: All registers in this table have corresponding CLR, SET and INV registers at their virtual addresses, plus offsets of 0x4, 0x8 and 0xC, respectively. See Section 11.2 "CLR, SET and INV Registers" for more information.

REGIST	ER 17-1: SPIxCON: SPI CONTROL REGISTER (CONTINUED)
bit 17	SPIFE: Frame Sync Pulse Edge Select bit (Framed SPI mode only)
	1 = Frame synchronization pulse coincides with the first bit clock
	0 = Frame synchronization pulse precedes the first bit clock
bit 16	ENHBUF: Enhanced Buffer Enable bit ⁽²⁾
	1 = Enhanced Buffer mode is enabled
	0 = Enhanced Buffer mode is disabled
bit 15	ON: SPI Peripheral On bit ⁽¹⁾
	1 = SPI Peripheral is enabled
	0 = SPI Peripheral is disabled
bit 14	Unimplemented: Read as '0'
bit 13	SIDL: Stop in Idle Mode bit
	1 = Discontinue module operation when the device enters Idle mode
	0 = Continue module operation when the device enters Idle mode
bit 12	DISSDO: Disable SDOx pin bit
	1 = SDOx pin is not used by the module. Pin is controlled by associated PORT register
	0 = SDOx pin is controlled by the module
bit 11-10	MODE<32,16>: 32/16-Bit Communication Select bits
	When AUDEN = 1:
	MODE32 MODE16 Communication
	1 1 24-bit Data, 32-bit FIFO, 32-bit Channel/64-bit Frame
	1 0 32-bit Data, 32-bit FIFO, 32-bit Channel/64-bit Frame
	0 1 16-bit Data, 16-bit FIFO, 32-bit Channel/64-bit Frame
	0 0 16-bit Data, 16-bit FIFO, 16-bit Channel/32-bit Frame
	When AUDEN = 0:
	MODE32 MODE16 Communication
	1 x 32-bit 0 1 16-bit
	0 1 10-51
bit 9	SMP: SPI Data Input Sample Phase bit
bit 5	Master mode (MSTEN = 1):
	1 = Input data sampled at end of data output time
	0 = Input data sampled at middle of data output time
	Slave mode (MSTEN = 0):
	SMP value is ignored when SPI is used in Slave mode. The module always uses SMP = 0.
	To write a '1' to this bit, the MSTEN value = 1 must first be written.
bit 8	CKE: SPI Clock Edge Select bit ⁽³⁾
	1 = Serial output data changes on transition from active clock state to Idle clock state (see the CKP bit)
	0 = Serial output data changes on transition from Idle clock state to active clock state (see the CKP bit)
bit 7	SSEN: Slave Select Enable (Slave mode) bit
	$1 = \overline{SSx}$ pin used for Slave mode
	0 = SSx pin not used for Slave mode, pin controlled by port function.
bit 6	CKP: Clock Polarity Select bit ⁽⁴⁾
	1 = Idle state for clock is a high level; active state is a low level
	0 = Idle state for clock is a low level; active state is a high level
Note 1:	When using the 1:1 PBCLK divisor, the user's software should not read or write the peripheral's SFRs in
	the SYSCLK cycle immediately following the instruction that clears the module's ON bit.
2:	This bit can only be written when the ON bit = 0 .
3:	This bit is not used in the Framed SPI mode. The user should program this bit to '0' for the Framed SPI
	mode (FRMEN = 1).
4:	When AUDEN = 1, the SPI module functions as if the CKP bit is equal to '1', regardless of the actual value
	of CKP.

2

REGISTER 19-1: UXMODE: UARTX MODE REGISTER (CONTINUED)

bit 5	 ABAUD: Auto-Baud Enable bit 1 = Enable baud rate measurement on the next character – requires reception of Sync character (0x55); cleared by hardware upon completion 0 = Baud rate measurement disabled or completed
bit 4	RXINV: Receive Polarity Inversion bit 1 = UxRX Idle state is '0' 0 = UxRX Idle state is '1'
bit 3	BRGH: High Baud Rate Enable bit 1 = High-Speed mode – 4x baud clock enabled 0 = Standard Speed mode – 16x baud clock enabled
bit 2-1	PDSEL<1:0>: Parity and Data Selection bits 11 = 9-bit data, no parity 10 = 8-bit data, odd parity 01 = 8-bit data, even parity 00 = 8-bit data, no parity
bit 0	STSEL: Stop Selection bit 1 = 2 Stop bits 0 = 1 Stop bit

Note 1: When using 1:1 PBCLK divisor, the user software should not read/write the peripheral SFRs in the SYSCLK cycle immediately following the instruction that clears the module's ON bit.

NOTES:

Bit Range	Bit 31/23/15/7	Bit 30/22/14/6	Bit 29/21/13/5	Bit 28/20/12/4	Bit 27/19/11/3	Bit 26/18/10/2	Bit 25/17/9/1	Bit 24/16/8/0					
24.04	R/P	R/P	R/P	R/P	r-1	r-1	r-1	r-1					
31:24	FVBUSONIO	FUSBIDIO	IOL1WAY	PMDL1WAY	_		_	_					
23:16	r-1	r-1	r-1	r-1	r-1	r-1	r-1	r-1					
23.10	—	—	_	—	_	_	-	—					
15.0	R/P	R/P	R/P	R/P	R/P	R/P	R/P	R/P					
15:8	USERID<15:8>												
7.0	R/P	R/P	R/P	R/P	R/P	R/P	R/P	R/P					
7:0				USERID<	7:0>								

REGISTER 27-4: DEVCFG3: DEVICE CONFIGURATION WORD 3

Legend:	r = Reserved bit	P = Programmable bit	
R = Readable bit	W = Writable bit	U = Unimplemented bit,	read as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 31 FVBUSONIO: USB VBUSON Selection bit

- 1 = VBUSON pin is controlled by the USB module 0 = VBUSON pin is controlled by the port function
- bit 30 **FUSBIDIO:** USB USBID Selection bit 1 = USBID pin is controlled by the USB module 0 = USBID pin is controlled by the port function
- bit 29 IOL1WAY: Peripheral Pin Select Configuration bit
 - 1 = Allow only one reconfiguration
 - 0 = Allow multiple reconfigurations
- bit 28 PMDI1WAY: Peripheral Module Disable Configuration bit
 - 1 = Allow only one reconfiguration
 - 0 = Allow multiple reconfigurations
- bit 27-16 Reserved: Write '1'
- bit 15-0 USERID<15:0>: User ID bits

This is a 16-bit value that is user-defined and is readable via ICSP™ and JTAG.

АС СНА	RACTERI	ISTICS	$\begin{array}{l} \mbox{Standard Operating Conditions: 2.3V to 3.6V} \\ \mbox{(unless otherwise stated)} \\ \mbox{Operating temperature} & -40^{\circ}C \leq TA \leq +85^{\circ}C \mbox{ for Industrial} \\ & -40^{\circ}C \leq TA \leq +105^{\circ}C \mbox{ for V-temp} \end{array}$							
Param. No.	Symbol	Characteristics	Min.	Typical ⁽¹⁾	Max.	Units	Conditions			
OS10	Fosc	External CLKI Frequency (External clocks allowed only in EC and ECPLL modes)	DC 4		40 40	MHz MHz	EC (Note 4) ECPLL (Note 3)			
OS11		Oscillator Crystal Frequency	3	—	10	MHz	XT (Note 4)			
OS12			4	—	10	MHz	XTPLL (Notes 3,4)			
OS13			10	—	25	MHz	HS (Note 5)			
OS14			10	-	25	MHz	HSPLL (Notes 3,4)			
OS15			32	32.768	100	kHz	Sosc (Note 4)			
OS20	Tosc	Tosc = 1/Fosc = Tcy (Note 2)	_	—	_	—	See parameter OS10 for Fosc value			
OS30	TosL, TosH	External Clock In (OSC1) High or Low Time	0.45 x Tosc	-	—	ns	EC (Note 4)			
OS31	TosR, TosF	External Clock In (OSC1) Rise or Fall Time	—	—	0.05 x Tosc	ns	EC (Note 4)			
OS40	Тоѕт	Oscillator Start-up Timer Period (Only applies to HS, HSPLL, XT, XTPLL and Sosc Clock Oscillator modes)	_	1024	_	Tosc	(Note 4)			
OS41	TFSCM	Primary Clock Fail Safe Time-out Period	—	2	_	ms	(Note 4)			
OS42	Gм	External Oscillator Transconductance (Primary Oscillator only)		12	—	mA/V	VDD = 3.3V, TA = +25°C (Note 4)			

TABLE 30-17: EXTERNAL CLOCK TIMING REQUIREMENTS

Note 1: Data in "Typical" column is at 3.3V, 25°C unless otherwise stated. Parameters are characterized but are not tested.

2: Instruction cycle period (Tcr) equals the input oscillator time base period. All specified values are based on characterization data for that particular oscillator type under standard operating conditions with the device executing code. Exceeding these specified limits may result in an unstable oscillator operation and/or higher than expected current consumption. All devices are tested to operate at "min." values with an external clock applied to the OSC1/CLKI pin.

3: PLL input requirements: 4 MHz \leq FPLLIN \leq 5 MHz (use PLL prescaler to reduce FOSC). This parameter is characterized, but tested at 10 MHz only at manufacturing.

4: This parameter is characterized, but not tested in manufacturing.

TABLE 30-18: PLL CLOCK TIMING SPECIFICATIONS

AC CHA	RACTERI	STICS	$\begin{array}{l} \mbox{Standard Operating Conditions: 2.3V to 3.6V} \\ \mbox{(unless otherwise stated)} \\ \mbox{Operating temperature} & -40^{\circ}C \leq TA \leq +85^{\circ}C \mbox{ for Industrial} \\ -40^{\circ}C \leq TA \leq +105^{\circ}C \mbox{ for V-temp} \end{array}$						
Param. No.	Symbol Characteristi			Min.	Typical	Max.	Units	Conditions	
OS50	Fplli	PLL Voltage Controlled Oscillator (VCO) Input Frequency Range		3.92	_	5	MHz	ECPLL, HSPLL, XTPLL, FRCPLL modes	
OS51	Fsys	On-Chip VCO Syste Frequency	m	60	—	120	MHz	_	
OS52	TLOCK	PLL Start-up Time (L	ock Time)	_	_	2	ms	—	
OS53	DCLK	CLKO Stability ⁽²⁾ (Period Jitter or Cum	-0.25	—	+0.25	%	Measured over 100 ms period		

Note 1: These parameters are characterized, but not tested in manufacturing.

2: This jitter specification is based on clock-cycle by clock-cycle measurements. To get the effective jitter for individual time-bases on communication clocks, use the following formula:

$$EffectiveJitter = \frac{D_{CLK}}{\sqrt{\frac{SYSCLK}{CommunicationClock}}}$$

For example, if SYSCLK = 40 MHz and SPI bit rate = 20 MHz, the effective jitter is as follows:

$$EffectiveJitter = \frac{D_{CLK}}{\sqrt{\frac{40}{20}}} = \frac{D_{CLK}}{1.41}$$

TABLE 30-19: INTERNAL FRC ACCURACY

АС СНА	RACTERISTICS	(unless	$\begin{array}{llllllllllllllllllllllllllllllllllll$								
Param. No.	Characteristics	Min.	Typical	Max.	Units	Conditions					
Internal	Internal FRC Accuracy @ 8.00 MHz ⁽¹⁾										
F20b FRC		-0.9		+0.9	%	_					

Note 1: Frequency calibrated at 25°C and 3.3V. The TUN bits can be used to compensate for temperature drift.

TABLE 30-20: INTERNAL LPRC ACCURACY

АС СНА	RACTERISTICS	$\begin{array}{l} \mbox{Standard Operating Conditions: 2.3V to 3.6V} \\ \mbox{(unless otherwise stated)} \\ \mbox{Operating temperature} & -40^{\circ}C \leq TA \leq +85^{\circ}C \mbox{ for Industrial} \\ & -40^{\circ}C \leq TA \leq +105^{\circ}C \mbox{ for V-temp} \end{array}$									
Param. No.	Characteristics	Min.	Typical	Max.	Units	Conditions					
LPRC @	LPRC @ 31.25 kHz ⁽¹⁾										
F21 LPRC		-15	—	+15	%	_					

Note 1: Change of LPRC frequency as VDD changes.

TABLE 30-32:	I2Cx BUS DATA	TIMING REQUIREMENTS	(MASTER MODE)	(CONTINUED)

АС СНА	RACTER	STICS		$\begin{array}{l} \mbox{Standard Operating Conditions: 2.3V to 3.6V} \\ \mbox{(unless otherwise stated)} \\ \mbox{Operating temperature} & -40^\circ C \leq TA \leq +85^\circ C \mbox{ for Industrial} \\ -40^\circ C \leq TA \leq +105^\circ C \mbox{ for V-temp} \end{array}$					
Param. No.	Symbol	Characteristics		Min. ⁽¹⁾	Max.	Units	Conditions		
IM40	TAA:SCL	Output Valid	100 kHz mode	—	3500	ns	—		
		from Clock	400 kHz mode	—	1000	ns	—		
			1 MHz mode (Note 2)	—	350	ns	—		
IM45	TBF:SDA	Bus Free Time	100 kHz mode	4.7	_	μS	The amount of time the		
			400 kHz mode	1.3	—	μS	bus must be free		
			1 MHz mode (Note 2)	0.5	—	μS	before a new transmission can start		
IM50	Св	Bus Capacitive L	oading	—	400	pF	—		
IM51	Tpgd	Pulse Gobbler D	elay	52	312	ns	See Note 3		

Note 1: BRG is the value of the I^2C Baud Rate Generator.

2: Maximum pin capacitance = 10 pF for all I2Cx pins (for 1 MHz mode only).

3: The typical value for this parameter is 104 ns.

PIC32MX1XX/2XX 28/36/44-PIN FAMILY

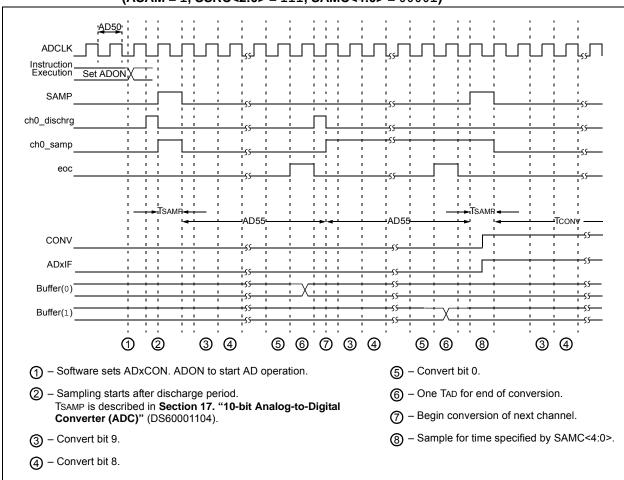


FIGURE 30-19: ANALOG-TO-DIGITAL CONVERSION (10-BIT MODE) TIMING CHARACTERISTICS (ASAM = 1, SSRC<2:0> = 111, SAMC<4:0> = 00001)

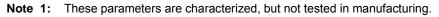
TABLE 30-39: PARALLEL MASTER PORT WRITE TIMING REQUIREMENTS

AC CHA	AC CHARACTERISTICS				$\label{eq:constraint} \begin{array}{l} \mbox{Standard Operating Conditions: 2.3V to 3.6V} \\ \mbox{(unless otherwise stated)} \\ \mbox{Operating temperature} & -40^{\circ}C \leq TA \leq +85^{\circ}C \mbox{ for Industrial} \\ & -40^{\circ}C \leq TA \leq +105^{\circ}C \mbox{ for V-temp} \end{array}$						
Param. No.	Symbol Characteristics ⁽¹⁾		Min.	Тур.	Max.	Units	Conditions				
PM11	Twr	PMWR Pulse Width	_	1 Трв	_	_	_				
PM12	TDVSU	Data Out Valid before PMWR or PMENB goes Inactive (data setup time)	—	2 Трв		_	_				
PM13 TDVHOLD PMWR or PMEMB Invalid to Data Out Invalid (data hold time)		—	1 Трв	_	_	—					

Note 1: These parameters are characterized, but not tested in manufacturing.

TABLE 30-40: OTG ELECTRICAL SPECIFICATIONS

AC CHARACTERISTICS			$\begin{array}{l} \mbox{Standard Operating Conditions: 2.3V to 3.6V} \\ \mbox{(unless otherwise stated)} \\ \mbox{Operating temperature} & -40^{\circ}C \leq TA \leq +85^{\circ}C \mbox{ for Industrial} \\ -40^{\circ}C \leq TA \leq +105^{\circ}C \mbox{ for V-temp} \end{array}$				
Param. No.	Symbol	Characteristics ⁽¹⁾	Min.	Тур.	Max.	Units	Conditions
USB313	VUSB3V3	USB Voltage	3.0		3.6	V	Voltage on VUSB3V3 must be in this range for proper USB operation
USB315	VILUSB	Input Low Voltage for USB Buffer	—	—	0.8	V	—
USB316	VIHUSB	Input High Voltage for USB Buffer	2.0	—	_	V	—
USB318	VDIFS	Differential Input Sensitivity	_	_	0.2	V	The difference between D+ and D- must exceed this value while VCM is met
USB319	VCM	Differential Common Mode Range	0.8		2.5	V	—
USB320	Zout	Driver Output Impedance	28.0	—	44.0	Ω	—
USB321	Vol	Voltage Output Low	0.0	_	0.3	V	1.425 kΩ load connected to VUSB3V3
USB322	Vон	Voltage Output High	2.8	_	3.6	V	1.425 kΩ load connected to ground



NOTES: